## Drivers/Receivers <br> EIA-232-E and CCITT V. 28

These devices are silicon gate CMOS ICs that combine both the transmitter and receiver to fulfill the electrical specifications of EIA Standard 232-E and CCITT V.28. The drivers feature true TTL input compatibility, slew rate limiting outputs, $300 \Omega$ power-off source impedance, and output typically switching to within $25 \%$ of the supply rails. The receivers can handle up to $\pm 25 \mathrm{~V}$ while presenting 3 to $7 \mathrm{k} \Omega$ impedance. Hysteresis in the receivers aid in the reception of noisy signals. By combining both drivers and receivers in a single CMOS chip, these devices provide efficient, low-power solutions for both EIA-232-E and V. 28 applications.

These devices offer the following performance features:

## Drivers

- $\pm 5$ to $\pm 12 \mathrm{~V}$ Supply Range
- $300 \Omega$ Power-Off Source Impedance
- Output Current Limiting
- TTL and CMOS Compatible Inputs
- Driver Slew Rate Range Limited to $30 \mathrm{~V} / \mu \mathrm{s}$ Maximum


## Receivers

- $\pm 25$ V Input Range
- 3 to $7 \mathrm{k} \Omega$ Input Impedance
- 0.8 V of Hysteresis for Enhanced Noise Immunity
- TTL and CMOS Compatible Outputs


## Available Driver/Receiver Combinations

| Device | Drivers | Receivers | Figure | No. of Pins |
| :---: | :---: | :---: | :---: | :---: |
| MC145403 | 3 | 5 | 1 | 20 |
| MC145404 | 4 | 4 | 2 | 20 |
| MC145405 | 5 | 3 | 3 | 20 |
| MC145408 | 5 | 5 | 4 | 24 |

Alternative EIA-232 devices to consider are:

## Three Supply

MC145406 (3 x 3)

Single Supply
MC145407 (3 x 3)
MC145705 ( $2 \times 3$ ) with Power Down
MC145706 (3 x 2) with Power Down
MC145707 (3 $\times 3$ ) with Power Down

## MC145403 MC145404 MC145405 MC145408



DW SUFFIX SOG PACKAGE CASE 751D

DW SUFFIX SOG PACKAGE CASE 751E

SD SUFFIX SSOP CASE 940B

| MC145403P | Plastic DIP |
| :--- | :--- |
| MC145404P | Plastic DIP |
| MC145405P | Plastic DIP |
| MC145408P | Plastic DIP |
| MC145403DW | SOG Package |
| MC145404DW | SOG Package |
| MC145405DW | SOG Package |
| MC145408DW | SOG Package |
| MC145405SD | SSOP |

PIN ASSIGNMENTS
(DIP, SOG, AND SSOP)


FUNCTIONAL DIAGRAM

RECEIVER


DRIVER


## ABSOLUTE MAXIMUM RATINGS

(Voltages referenced to GND, except where noted)

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| DC Supply Voltage ( $\mathrm{V}_{\mathrm{DD}} \geq \mathrm{V}_{\mathrm{CC}}$ ) | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}} \\ & \mathrm{~V}_{\mathrm{SS}} \\ & \mathrm{~V}_{\mathrm{CC}} \end{aligned}$ | $\begin{aligned} & -0.5 \text { to }+13.5 \\ & +0.5 \text { to }-13.5 \\ & -0.5 \text { to }+6.0 \end{aligned}$ | V |
| Input Voltage Range $\begin{array}{r} \text { Rx1 - Rxn } \\ \text { DI1 - DIn } \end{array}$ | $\mathrm{V}_{\mathrm{IR}}$ | $\begin{gathered} V_{S S}-15 \text { to } V_{D D}+15 \\ 0.5 \text { to } V_{C C}+15 \end{gathered}$ | V |
| DC Current Drain per Pin | 1 | $\pm 00$ | mA |
| Power Dissipation | $\mathrm{PD}_{\text {D }}$ | 1 | W |
| Operating Temperature Range | $\mathrm{T}_{\text {A }}$ | -40 to + 85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -85 to + 150 | ${ }^{\circ} \mathrm{C}$ |

This device contains circuitry to protect the inputs and outputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid applications of any voltage higher than maximum rated voltages to this high impedance circuit.

For proper operation it is recommended that $V_{\text {out }}$ and $\mathrm{V}_{\text {in }}$ be constrained to the ranges described as follows:

Digital I/O: Driver Inputs (DI): ( $\mathrm{GND} \leq \mathrm{V}_{\mathrm{DI}} \leq \mathrm{V}_{\mathrm{CC}}$ )
Receiver Outputs (DO): (GND $\left.\leq \mathrm{V}_{\mathrm{DO}} \leq \mathrm{V}_{\mathrm{CC}}\right)$.
EIA-232 I/O: Driver Outputs (Tx):

$$
\left(\mathrm{V}_{\mathrm{SS}} \leq \mathrm{V}_{\mathrm{Tx} 1}-\mathrm{Tx} n \leq \mathrm{V}_{\mathrm{DD}}\right)
$$

Receiver Inputs ( Rx ):

$$
\mathrm{V}_{\mathrm{SS}}-15 \mathrm{~V} \leq \mathrm{V}_{\mathrm{Rx} 1}-\mathrm{Rxn} \leq \mathrm{V}_{\mathrm{DD}}
$$

$$
\text { + } 15 \mathrm{~V})
$$

Reliability of operation is enhanced if unused outputs are tied off to an appropriate logic voltage level (e.g., either GND or $\mathrm{V}_{\mathrm{CC}}$ for DI , and GND for Rx).

DC ELECTRICAL CHARACTERISTICS (All polarities referenced to GND $=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40$ to $+85^{\circ} \mathrm{C}$ )

| Parameter | Symbol | Min | Typ | Max | Unit |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| DC Supply Voltage |  | $\mathrm{V}_{\mathrm{DD}}$ | 4.5 | 5 to 12 | 13.2 | V |
|  |  | $\mathrm{VSS}_{\mathrm{CC}}$ | -4.5 | -5 to -12 | -13.2 |  |
| Quiescent Supply Current (Outputs Unloaded, Inputs Low) | $\mathrm{V}_{\mathrm{DD}}=+12 \mathrm{~V}$ | IDD | - | 5 | 5.5 |  |
|  | $\mathrm{~V}_{\mathrm{SS}}=-12 \mathrm{~V}$ | ISS | - | 425 | 635 | $\mu \mathrm{~A}$ |
|  | $\mathrm{~V}_{\mathrm{CC}}=+5 \mathrm{~V}$ | ICC | - | -400 | -600 |  |

RECEIVER ELECTRICAL SPECIFICATIONS
(Voltage polarities referenced to $\mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+12 \mathrm{~V}, \mathrm{~V} S=-12 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40$ to $+85^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}, \pm 10 \%$ )

| Characteristic |  | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Turn-On Threshold $\mathrm{V}_{\mathrm{DO}}=\mathrm{V}_{\mathrm{OL}}$ | Rx1-Rxn | $\mathrm{V}_{\text {on }}$ | 1.35 | 1.8 | 2.35 | V |
| Input Turn-Off Threshold $\mathrm{V}_{\mathrm{DO}}=\mathrm{V}_{\mathrm{OH}}$ | Rx1-Rxn | $\mathrm{V}_{\text {off }}$ | 0.75 | 1 | 1.25 | V |
| Input Threshold Hysteresis $\Delta=V_{\text {on }}-V_{\text {off }}$ |  | $V_{\text {hys }}$ | 0.6 | 0.8 | - | V |
| Input Resistance $\left(V_{S S}-15 \mathrm{~V}\right) \leq \mathrm{V} \times 1-R \times n \leq\left(V_{D D}+15 \mathrm{~V}\right)$ |  | $\mathrm{R}_{\text {in }}$ | 3 | 5.4 | 7 | k $\Omega$ |
| High Level Output Voltage $\mathrm{V}_{\mathrm{Rx}}=-3 \text { to }-25 \mathrm{~V}^{*}(\mathrm{DO} 1-\mathrm{DO})$ | $\begin{aligned} & \mathrm{I}_{\text {out }}=-20 \mu \mathrm{~A} \\ & \text { Iout }=-1.0 \mathrm{~mA} \end{aligned}$ | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & 4.9 \\ & 3.8 \end{aligned}$ | $\begin{aligned} & 4.9 \\ & 4.3 \end{aligned}$ |  | V |
| Low Level Output Voltage $\mathrm{V}_{\mathrm{Rx}}=+3 \text { to }+25 \mathrm{~V}^{*}(\mathrm{DO} 1-\mathrm{DO} n)$ | $\begin{aligned} & \mathrm{l}_{\text {out }}=+2 \mathrm{~mA} \\ & \mathrm{l}_{\text {out }}=+4 \mathrm{~mA} \end{aligned}$ | $\mathrm{V}_{\mathrm{OL}}$ |  | $\begin{gathered} \hline 0.02 \\ 0.5 \end{gathered}$ | $\begin{aligned} & 0.5 \\ & 0.7 \end{aligned}$ | V |

[^0]
## DRIVER ELECTRICAL SPECIFICATIONS

(Voltage Polarities Referenced to $\mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+12 \mathrm{~V}, \mathrm{~V} S=-12 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40$ to $+85^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}, \pm 10 \%$ )

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: |
| Digital <br> Logic 0 |  |  |  |  |  |
| Logic 1 |  |  |  |  |  |

*Voltage specifications are in terms of absolute values.
** Specification is for one Tx output pin to be shorted at a time. Should all three driver outputs be shorted simultaneously, device power dissipation limits will be exceeded.
*** This condition could exceed package limitations.

SWITCHING CHARACTERISTICS $\left(\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}, \pm 10 \%, \mathrm{~V}_{\mathrm{DD}}=+12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-12 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40\right.$ to $+85^{\circ} \mathrm{C}$; See Figures 2 and 3 )

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- |

Drivers

| $\begin{aligned} & \text { Propagation Delay Time Tx } \\ & \text { Low-to-High } \\ & R_{L}=3 \mathrm{k} \Omega, C_{L}=50 \mathrm{pF} \end{aligned}$ | ${ }^{\text {tPLH }}$ | - | 500 | 1000 | ns |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { High-to-Low } \\ & \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \end{aligned}$ | tPHL | - | 700 | 1000 |  |
| Output Slew Rate Minimum Load $\mathrm{R}_{\mathrm{L}}=7 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=0 \mathrm{pF}\left(\mathrm{~V}_{\mathrm{DD}}=6 \text { to } 12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-6 \text { to }-12 \mathrm{~V}\right)$ | SR | - | $\pm 6$ | $\pm 30$ | $\mathrm{V} / \mathrm{\mu s}$ |
| Maximum Load $R_{L}=3 \mathrm{k} \Omega, C_{L}=2500 \mathrm{pF}\left(\mathrm{~V}_{\mathrm{DD}}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-12 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V}\right)$ |  | 4 | - | - |  |

Receivers ( $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ )

| Propagation Delay Time Low-to-High | tplH | - | 360 | 610 | ns |
| :---: | :---: | :---: | :---: | :---: | :---: |
| High-to-Low | tPHL | - | 130 | 610 |  |
| Output Rise Time | $\mathrm{tr}_{r}$ | - | 250 | 400 | ns |
| Output Fall Time | $t_{f}$ | - | 40 | 100 | ns |



Figure 1. Power-Off Source Resistance Illustrated for MC145408


Figure 2. Switching Characteristics

## PIN DESCRIPTIONS

## Vcc

Digital Power Supply
The digital supply pin, which is connected to the logic power supply (+5.5 V maximum).

## GND

Ground
Ground return pin is typically connected to the signal ground pin of the EIA-232-E connector (Pin 7) as well as to the logic power supply ground.

## VDD <br> Most Positive Device Pin

The most positive power supply pin, which is typically +5 to +12 V .

DRIVERS


Figure 3. Slew Rate Characteristics

VSS
Most Negative Device Pin
The most negative power supply pin, which is typically -5 to -12 V .

Rx1-Rxn
Receive Data Input Pins
These are the EIA-232-E receive signal inputs. A voltage between +3 and +25 V is decoded as a space, and causes the corresponding DO pin to swing to ground ( 0 V ). A voltage between -3 and -25 V is decoded as a mark, and causes the corresponding DO pin to swing to $\mathrm{V}_{\mathrm{CC}}$.

## DO1 - DOn <br> Data Output Pins

These are the receiver digital output pins which swing from $V_{C C}$ to GND. Each output pin is capable of driving one LSTTL input load.

## DI1 - DIn

## Data Input Pins

These are the high impedance digital input pins to the drivers. Input voltage levels on these pins are LSTTL compatible and must be between $\mathrm{V}_{\mathrm{CC}}$ and GND. A weak pull-up on each input sets all unused DI pins to $\mathrm{V}_{\mathrm{CC}}$, causing the corresponding unused driver outputs to be at $\mathrm{V}_{\mathrm{SS}}$.

## Tx1 - TXn

## Transmit Data Output Pins

These are the EIA-232-E transmit signal output pins, which swing from $\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\mathrm{SS}}$. A logic 1 at the Dl input causes the corresponding Tx output to swing to $\mathrm{V}_{\mathrm{SS}}$. A logic 0 at the DI input causes the corresponding Tx out to swing to VDD. The actual levels and slew rate achieved will depend on the output loading ( $R_{L} \| C_{L}$ ).

## APPLICATION INFORMATION

## POWER SUPPLY CONSIDERATIONS

Figure 4 shows a technique to guard against excessive device current.

The diode D1 prevents excessive current from flowing through an internal diode from the $\mathrm{V}_{\mathrm{CC}}$ pin to the $\mathrm{V}_{\mathrm{DD}}$ pin when $\mathrm{V}_{\mathrm{DD}}<\mathrm{V}_{\mathrm{CC}}$ by approximately 0.6 V or greater. This high current condition can exist for a short period of time during power up/down. Additionally, if the +12 V supply is switched
off while the +5 V is on and the off supply is a low impedance to ground, the diode D1 will prevent current flow through the internal diode.

The diode D2 is used as a voltage clamp, to prevent VSS from drifting positive to $V_{C C}$, in the event that power is removed from $\mathrm{V}_{\text {SS }}$ (Pin 12). If $\mathrm{V}_{\text {SS }}$ power is removed, and the impedance from the $V_{S S}$ pin to ground is greater than approximately $3 \mathrm{k} \Omega$, this pin will be pulled to $\mathrm{V}_{\mathrm{CC}}$ by internal circuitry causing excessive current in the $\mathrm{V}_{\mathrm{CC}}$ pin.

If by design, neither of the above conditions are allowed to exist, then the diodes D1 and D2 are not required.

## ESD PROTECTION

ESD protection on IC devices that have their pins accessible to the outside world is essential. High static voltages applied to the pins when someone touches them either directly or indirectly can cause damage to gate oxides and transistor junctions by coupling a portion of the energy from the I/O pin to the power supply buses of the IC. This coupling will usually occur through the internal ESD protection diodes. The key to protecting the IC is to shunt as much of the energy to ground as possible before it enters the IC. Figure 4 shows a technique which will clamp the ESD voltage at approximately $\pm 15 \mathrm{~V}$ using the MMBZ15VDLT1. Any residual voltage which appears on the supply pins is shunted to ground through the capacitors C1-C3. This scheme has provided protection to the interface part up to $\pm 10 \mathrm{kV}$, using the human body model test.


Figure 4.

## PACKAGE DIMENSIONS

P SUFFIX
PLASTIC DIP
CASE 738-03

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION LTO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

| DIM | INCHES |  | MILLIMETERS |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 1.010 | 1.070 | 25.66 | 27.17 |
| B | 0.240 | 0.260 | 6.10 | 6.60 |
| C | 0.150 | 0.180 | 3.81 | 4.57 |
| D | 0.015 | 0.022 | 0.39 | 0.55 |
| E | 0.050 BSC |  | 1.27 BSC |  |
| F | 0.050 | 0.070 | 1.27 | 1.77 |
| G | 0.100 BSC |  | 2.54 BSC |  |
| J | 0.008 | 0.015 | 0.21 | 0.38 |
| K | 0.110 | 0.140 | 2.80 | 3.55 |
| L | 0.300 BSC |  | 7.62 BSC |  |
| M | $0^{\circ}$ | $15^{\circ}$ | $0^{\circ}$ | $15^{\circ}$ |
| N | 0.020 | 0.040 | 0.51 | 1.01 |

P SUFFIX
PLASTIC DIP
CASE 724-03


NOTES:

1. CHAMFERED CONTOUR OPTIONAL.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL
3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
4. CONTROLLING DIMENSION: INCH

| DIM | INCHES |  | MILLIMETERS |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 1.230 | 1.265 | 31.25 | 32.13 |
| B | 0.250 | 0.270 | 6.35 | 6.85 |
| C | 0.145 | 0.175 | 3.69 | 4.44 |
| D | 0.015 | 0.020 | 0.38 | 0.51 |
| E | 0.050 BSC |  | 1.27 BSC |  |
| F | 0.040 | 0.060 | 1.02 | 1.52 |
| G | 0.100 BSC |  | 2.54 BSC |  |
| J | 0.007 | 0.012 | 0.18 | 0.30 |
| K | 0.110 | 0.140 | 2.80 | 3.55 |
| L | 0.300 BSC |  | 7.62 BSC |  |
| M | $0^{\circ}$ | $15^{\circ}$ | $0^{\circ}$ | $15^{\circ}$ |
| N | 0.020 | 0.040 | 0.51 | 1.01 |

DW SUFFIX SOG PACKAGE CASE 751D-04

NOTES:

1. DIMENSIONING AND TOLERANCING PER
ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE
MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.150
(0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE
DAMBAR PROTRUSION. ALLOWABLE
DAMBAR PROTRUSION SHALL BE 0.13
(0.005) TOTAL IN EXCESS OF D DIMENSION
AT MAXIMUM MATERIAL CONDITION.

|  | MILLIMETERS | INCHES |  |  |
| :--- | ---: | ---: | ---: | ---: |
| DIM | MIN | MAX | MIN | MAX |
| A | 12.65 | 12.95 | 0.499 | 0.510 |
| B | 7.40 | 7.60 | 0.292 | 0.299 |
| C | 2.35 | 2.65 | 0.093 | 0.104 |
| D | 0.35 | 0.49 | 0.014 | 0.019 |
| F | 0.50 | 0.90 | 0.020 | 0.035 |
| G | 1.27 | BSC | 0.050 | BSC |
| J | 0.25 | 0.32 | 0.010 | 0.012 |
| K | 0.10 | 0.25 | 0.004 | 0.009 |
| M | $0 \circ$ | $7 \circ$ | $0{ }^{\circ}$ | $7 \circ$ |
| P | 10.05 | 10.55 | 0.395 | 0.415 |
| R | 0.25 | 0.75 | 0.010 | 0.029 |



notes:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD DIMENSION B DOES NOT INCLUDE INTERLEAD
OLASH PROTRUSION. INTERLEAD FLASH OR FLASH OR PROTRUSION. INTERLEAD FLASH OR
PROTRUSION SHALL NOT EXCEED $0.15(0.006)$ PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE $0.13(0.005)$ TOTAL IN EXCESS OF K DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION K BY MORE THAN 0.07 ( 0.002 ) AT LEAST MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED DIMENSION A AND B AR
AT DATUM PLANE -W-.

|  | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | MAX | MIN | MAX |
| A | 6.07 | 6.33 | 0.238 | 0.249 |
| B | 5.20 | 5.38 | 0.205 | 0.212 |
| C | 1.73 | 1.99 | 0.068 | 0.078 |
| D | 0.05 | 0.21 | 0.002 | 0.008 |
| F | 0.63 | 0.95 | 0.024 | 0.037 |
| G | 0.65 BSC |  | 0.026 BSC |  |
| H | 0.73 | 0.90 | 0.028 | 0.035 |
| J | 0.09 | 0.20 | 0.003 | 0.008 |
| J1 | 0.09 | 0.16 | 0.003 | 0.006 |
| K | 0.25 | 0.38 | 0.010 | 0.015 |
| K1 | 0.25 | 0.33 | 0.010 | 0.013 |
| L | 7.65 | 7.90 | 0.301 | 0.311 |
| M | $0 \circ$ | $8 \circ$ | $0 \circ$ | $8{ }^{\circ}$ |

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[^0]:    * This is the range of input voltages as specified by EIA-232-E to cause a receiver to be in the high or low.

